## PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data		
1.1 Company	<b>577</b>	STMicroelectronics International N.V
1.2 PCI No.		ADG/21/13008
1.3 Title of PCI		SOT23 – Power FLAT: Additional Cover Tape Supplier
1.4 Product Category		see list
1.5 Issue date		2021-09-16

2. PCI Team		
2.1 Contact supplier		
2.1.1 Name	KRISZTINA NEMETH	
2.1.2 Phone	+49 89460062210	
2.1.3 Email	krisztina.nemeth@st.com	
2.2 Change responsibility		
2.2.1 Product Manager	Mario ASTUTI,Stephane CHAMARD,Angelo RAO	
2.1.2 Marketing Manager	Anna RANIOLO, Michele SCUTO, Philippe LEGER, Natale Sandro D'ANGELO	
2.1.3 Quality Manager	Vincenzo MILITANO, Jean-Paul REBRASSE	

3. Change		
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Materials	New Indirect material part number (same supplier or different supplier): Boxes, trays, carriers, back grinding tape, wafer mounting tape, mold tape, etc	

4. Description of change		
	Old New	
4.1 Description	Cover tape Supplier: Denka	Cover tape Suppliers : Denka, Sumitomo
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No Impact	

5. Reason / motivation for change	
5.1 Motivation	Double Source Suppliers for Service improvement
5.2 Customer Benefit	SERVICE IMPROVEMENT

6. Marking of parts / traceability of change		
6.1 Description	Date code	

7. Timing / schedule		
7.1 Date of qualification results	2021-09-07	
7.2 Intended start of delivery	2021-10-31	
7.3 Qualification sample available?	Upon Request	

8. Qualification / Validation			
8.1 Description 13008 Qualification TFME Additional supplier for cover tape.pptx			
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2021-09-16

## 9. Attachments (additional documentations)

13008 Public product.pdf 13008 Add supplier TFME cover tape.pdf 13008 Qualification TFME Additional supplier for cover tape.pptx

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	ESDA6V1BC6	
	ESDA6V1SC6	
	USBLC6-2SC6	
	USBLC6-4SC6	

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